TOSHIBA CCD Image Sensor CCD (charge coupled device)

# **TCD2560D**

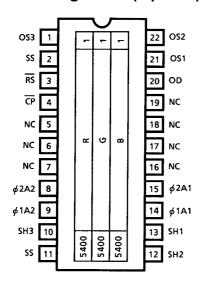
The TCD2560D is a high sensitive and low dark current 5400 elements  $\times$  3 line CCD color image sensor which includes CCD drive circuit and clamp circuit. The sensor is designed for scanner.

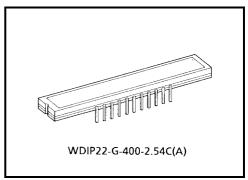
The device contains a row of 5400 elements  $\times$  3 line photodiodes which provide a 24 lines/mm (600 dpi) across a A4 size paper. The device is operated by 5 V pulse, and 12 V power supply.

#### **Features**

- Number of image sensing elements: 5400 elements × 3 line
- Image sensing element size: 5.25 μm by 5.25 μm on 5.25 μm centers
- Photo sensing region: High sensitive and low dark current PN photodiode
- Distance between photodiode array: 42 µm (8 lines)
- Clock: 2 phase (5 V)
- Power supply: 12 V power supply voltage
- Internal circuit: Clamp circuit
- Package: 22 pin CERDIP package
- Color filter: Red, green, blue

#### Pin Assignment (top view)





Weight: 4.5 g (typ.)

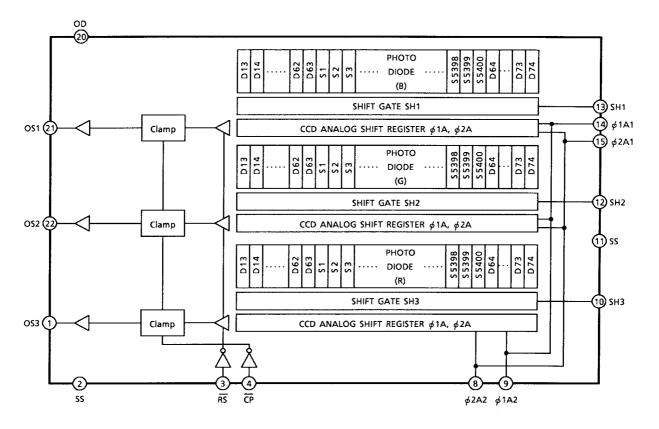
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### **Maximum Ratings (Note 1)**

| Characteristics       | Symbol              | Rating   | Unit |
|-----------------------|---------------------|----------|------|
| Clock pulse voltage   | VφA                 |          | V    |
| Shift pulse voltage   | V <sub>SH</sub>     | -0.3~8.0 | V    |
| Reset pulse voltage   | $V_{\overline{RS}}$ | -0.5 0.0 | V    |
| Clamp pulse voltage   | V <sub>CP</sub>     |          | V    |
| Power supply voltage  | V <sub>OD</sub>     | -0.3~15  | V    |
| Operating temperature | T <sub>opr</sub>    | 0~60     | °C   |
| Storage temperature   | T <sub>stg</sub>    | -25~85   | °C   |

Note 1: All voltage are with respect to SS terminals (ground).

### **Circuit Diagram**



### **Pin Names**

| Pin No. | Symbol | Name                  | Pin No. | Symbol | Name                    |
|---------|--------|-----------------------|---------|--------|-------------------------|
| 1       | OS3    | Signal Output 3 (red) | 12      | SH2    | Shift Gate 2            |
| 2       | SS     | Ground                | 13      | SH1    | Shift Gate 1            |
| 3       | RS     | Reset Gate            | 14      | φ1Α1   | Clock 1 (phase 1)       |
| 4       | СP     | Clamp Gate            | 15      | φ2A1   | Clock 1 (phase 2)       |
| 5       | NC     | Non Connection        | 16      | NC     | Non Connection          |
| 6       | NC     | Non Connection        | 17      | NC     | Non Connection          |
| 7       | NC     | Non Connection        | 18      | NC     | Non Connection          |
| 8       | φ2A2   | Clock 2 (phase 2)     | 19      | NC     | Non Connection          |
| 9       | φ1A2   | Clock 2 (phase 1)     | 20      | OD     | Power                   |
| 10      | SH3    | Shift Gate 3          | 21      | OS1    | Signal Output 1 (blue)  |
| 11      | SS     | Ground                | 22      | OS2    | Signal Output 2 (green) |

#### **Optical/Electrical Characteristics**

(Ta = 25°C, 
$$V_{OD}$$
 = 12 V,  $V_{\varphi}$  =  $V_{SH}$  =  $V_{\overline{RS}}$  =  $V_{\overline{CP}}$  = 5 V (pulse),  $f_{\varphi}$  = 1.0 MHz,

 $f_{\overline{RS}} = 1$  MHz,  $t_{INT} = 10$  ms, light source = light source A + CM500S filter (t = 1 mm),

load resistance =  $100 \text{ k}\Omega$ )

| Characteristic                 | es    | Symbol           | Min | Тур. | Max | Unit   | Note     |
|--------------------------------|-------|------------------|-----|------|-----|--------|----------|
|                                | Red   | R (R)            | 3.4 | 4.8  | 6.2 |        |          |
| Sensitivity                    | Green | R (G)            | 4.7 | 6.7  | 8.7 | V/lx·s | (Note 2) |
|                                | Blue  | R (B)            | 2.0 | 2.9  | 3.8 |        |          |
| Photo reaponee non uniformity  | ·     | PRNU (1)         | _   | 15   | 20  | %      | (Note 3) |
| Photo response non uniformity  |       | PRNU (3)         | _   | 3    | 12  | mV     | (Note 4) |
| Saturation output voltage      |       | V <sub>SAT</sub> | 2.5 | 3.0  | _   | V      | (Note 5) |
| Saturation exposure            |       | SE               | _   | 0.45 | _   | lx⋅s   | (Note 6) |
| Dark signal voltage            |       | V <sub>DRK</sub> | _   | 0.5  | 3.0 | mV     | (Note 7) |
| Dark signal non uniformity     |       | DSNU             | _   | 2.0  | 9.0 | mV     | (Note 7) |
| DC power dissipation           |       | P <sub>D</sub>   | _   | 300  | 400 | mW     |          |
| Total transfer efficiency      |       | TTE              | 92  | 98   | _   | %      |          |
| Output impedance               |       | Z <sub>O</sub>   | _   | 0.3  | 1.0 | kΩ     |          |
| DC compensation output voltage |       | Vos              | 4.0 | 5.0  | 6.0 | V      | (Note 8) |
| Random noise                   |       | N <sub>D</sub> σ | _   | 1.0  | _   | mV     | (Note 9) |
| Reset noise                    |       | V <sub>RSN</sub> | _   | 0.3  | 1.0 | V      | (Note 8) |
| Masking noise                  |       | V <sub>MS</sub>  | _   | 0.1  | 0.5 | V      | (Note 8) |

Note 2: Sensitivity is defined for each color of signal outputs average when the photosensitive surface is applied with the light of uniform illumination and uniform color temperature.

Note 3: PRNU (1) is defined for each color on a single chip by the expressions below when the photosensitive surface is applied with the light of uniform illumination and uniform color temperature.

PRNU (1) = 
$$\frac{\Delta \chi}{\overline{\chi}} \times 100 \text{ (%)}$$

Where  $\bar{\chi}$  is average of total signal output and  $\Delta\chi$  is the maximum deviation from  $\bar{\chi}$ . The amount of incident light is shown below.

 $Red = 1/2 \cdot SE$ 

Green = 1/2·SE

Blue =  $1/4 \cdot SE$ 

Note 4: PRNU (3) is defined as maximum voltage with next pixels, where measured at 5% of SE (typ.).

Note 5: V<sub>SAT</sub> is defined as minimum saturation output of all effective pixels.

Note 6: Definition of SE

$$SE = \frac{V_{SAT}}{R_{G}} (Ix \cdot s)$$

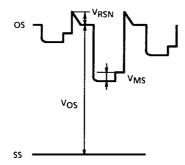
Note 7: V<sub>DRK</sub> is defined as average dark signal voltage of all effective pixels.

DSNU is defined as different voltage between  $V_{DRK}$  and  $V_{MDK}$  when  $V_{MDK}$  is maximum dark signal voltage.

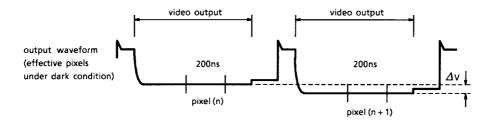


#### Note 8: DC signal output voltage is defined as follows.

Reset Noise Voltage is defined as follows.



Note 9: Random noise is defined as the standard deviation (sigma) of the output level difference between two adjacent effective pixels under no illumination (i.e. dark conditions) calculated by the following procedure.



- 1) Two adjacent pixels (pixel n and n + 1) in one reading are fixed as measurement points.
- 2) Each of the output level at video output periods averaged over 200ns period to get V (n) and V (n + 1).
- 3) V(n + 1) is subtracted from V(n) to get  $\Delta V$ .

$$\Delta V = V(n) - V(n+1)$$

4) The standard deviation of  $\Delta V$  is calculated after procedure 2) and 3) are repeated 30 times (30 readings).

$$\overline{\Delta V} = \frac{1}{30} \sum_{i=1}^{30} \left| \Delta Vi \right| \qquad \qquad \sigma = \sqrt{\frac{1}{30} \sum_{i=1}^{30} \left( \left| \Delta Vi \right| - \overline{\Delta V} \right)^2}$$

- 5) Procedure 2), 3) and 4) are repeated 10 times to get sigma value.
- 6) 10 sigma values are averaged.

$$\overline{\sigma} = \frac{1}{10} \sum_{j=1}^{10} \sigma j$$

7)  $\sigma$  value calculated using the above procedure is observed  $\sqrt{2}$  times larger than that measured relative to the ground level. So we specify random noise as follows.

$$N_D \sigma = \frac{1}{\sqrt{2}} \frac{1}{\sigma}$$

### **Operating Condition**

| Characteristics      |           | Symbol              | Min                 | Тур.       | Max        | Unit | Note     |
|----------------------|-----------|---------------------|---------------------|------------|------------|------|----------|
| Clock pulse voltage  | "H" level | \/± A               | 4.5                 | 5.0        | 5.5        | V    |          |
| Clock pulse voltage  | "L" level | VφA                 | 0                   | 0          | 0.3        | V    |          |
| Shift pulse voltage  | "H" level | V <sub>SH</sub>     | VφA<br>"H"<br>– 0.5 | VφA<br>"H" | VφA<br>"H" | V    | (Note10) |
| "L" level            |           |                     | 0                   | 0          | 0.5        |      |          |
| Peact pulse voltage  | "H" level | \ <i>/</i>          | 4.5                 | 5.0        | 5.5        | V    |          |
| Reset pulse voltage  | "L" level | V <sub>RS</sub>     | 0                   | 0          | 0.5        | V    |          |
| Clamp pulse voltage  | "H" level | \/                  | 4.5                 | 5.0        | 5.5        | V    |          |
| Clamp pulse voltage  | "L" level | $V_{\overline{CP}}$ | 0                   | 0          | 0.5        | V    |          |
| Power supply voltage |           | V <sub>OD</sub>     | 11.4                | 12.0       | 13.0       | V    |          |

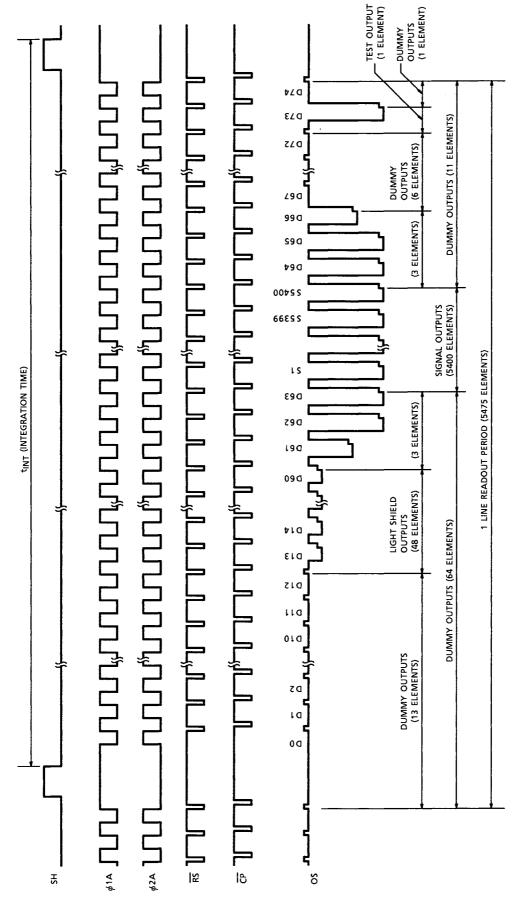
Note 10:  $V\phi A$  "H" means the high level voltage of  $V\phi A$  when SH pulse is high level.

### Clock Characteristics (Ta = 25°C)

| Characteristics             | Symbol          | Min | Тур. | Max | Unit |
|-----------------------------|-----------------|-----|------|-----|------|
| Clock pulse frequency       | fφA             | 0.3 | 1.0  | 6.0 | MHz  |
| Reset pulse frequency       | f <sub>RS</sub> | 0.3 | 1.0  | 6.0 | MHz  |
| Clamp pulse frequency       | f <sub>CP</sub> | 0.3 | 1.0  | 6.0 | MHz  |
| Clock 1 capacitance (Note 1 | ) Cφ1           | _   | 190  | 300 | pF   |
| Clock 2 capacitance (Note 1 | ) Cφ2           | _   | 160  | 300 | pF   |
| Shift gate capacitance      | C <sub>SH</sub> | _   | 20   | 100 | pF   |
| Reset gate capacitance      | C <sub>RS</sub> | _   | 10   | 40  | pF   |
| Clamp gate capacitance      | C <sub>CP</sub> | _   | 10   | 40  | pF   |

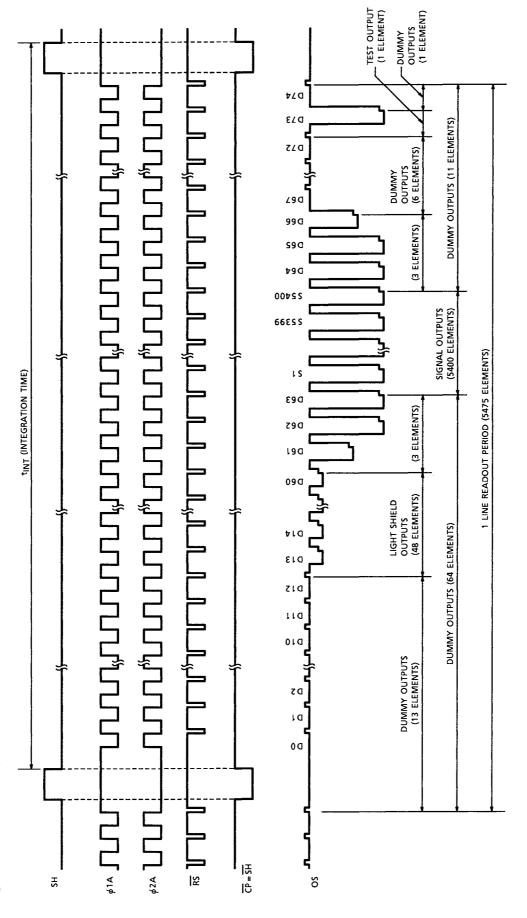
Note 11:  $V_{OD} = 12 \text{ V}$ 

Timing Chart (bit clamp mode)



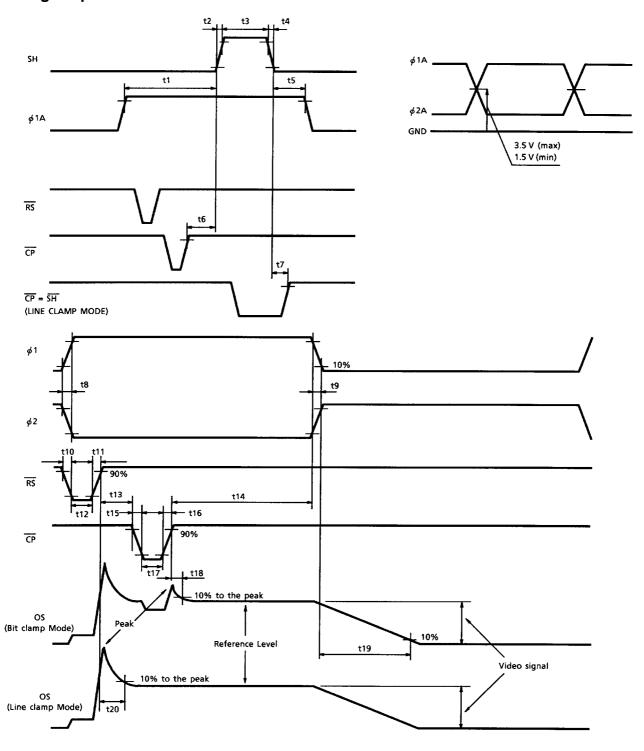
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Timing Chart (line clamp mode)



2002-12-25

### **Timing Requirements**



### **Timing Requirements**

| Characteristics   | Symbol   | Min          | Typ.<br>(Note 12) | Max             | Unit |
|---|----------|--------------|-------------------|-----------------|------|
| Pulse timing of SH and ∮1                                       | t1       | 120          | 1000              | _               | ns   |
| Fulse titling of SΠ and φ1                                      | t5       | 800          | 1000              | _               | 115  |
| SH pulse rise time, fall time                                   | t2, t4   | 0            | 50                | _               | ns   |
| SH pulse width  | t3       | 3000         | 5000              | _               | ns   |
| Pulse timing of SH and CP                                       | t6       | 200          | 500               | _               | ns   |
| Pulse timing of SH and $\overline{\text{CP}}$ (line clamp mode) | t7       | 10           | 100               | _               | ns   |
| φ1, φ2 pulse rise time, fall time                               | t8, t9   | 0            | 50                | _               | ns   |
| RS pulse rise time, fall time                                   | t10, t11 | 0            | 20                | _               | ns   |
| RS pulse width  | t12      | 30           | 80                | _               | ns   |
| Pulse timing of RS and CP                                       | t13      | 10           | 20                | _               | ns   |
| Pulse timing of $\phi$ 1A, $\phi$ 2A and $\overline{CP}$        | t14      | 0            | 20                | _               | ns   |
| CP pulse rise time, fall time                                   | t15, t16 | 0            | 20                | _               | ns   |
| CP pulse width (Note 13)  | t17      | 40<br>(3000) | 80<br>(5000)      |                 | ns   |
| Reference level settle time (bit clamp mode)                    | t18      | _            | 35                | 45<br>(Note 16) | ns   |
| Video data delay time (Note 14)                                 | t19      | _            | 40                | 60<br>(Note 15) | ns   |
| Reference level settle time (line clamp mode)                   | t20      | _            | 60                | 70<br>(Note 16) | ns   |

Note 12: Typ. is the case of  $f_{\overline{RS}} = 1.0 \text{ MHz}$ 

Note 13: Line clamp Mode inside ( ).

Note 14: Load resistance is 100 k $\Omega$ 

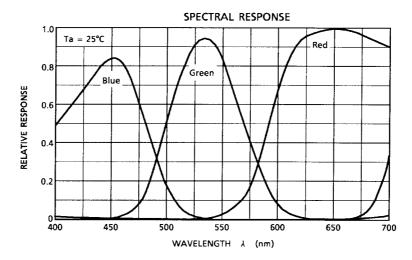
Note 15: Typical settle time to about 1% of final value

Note 16: Typical settle time to about 1% of the peak

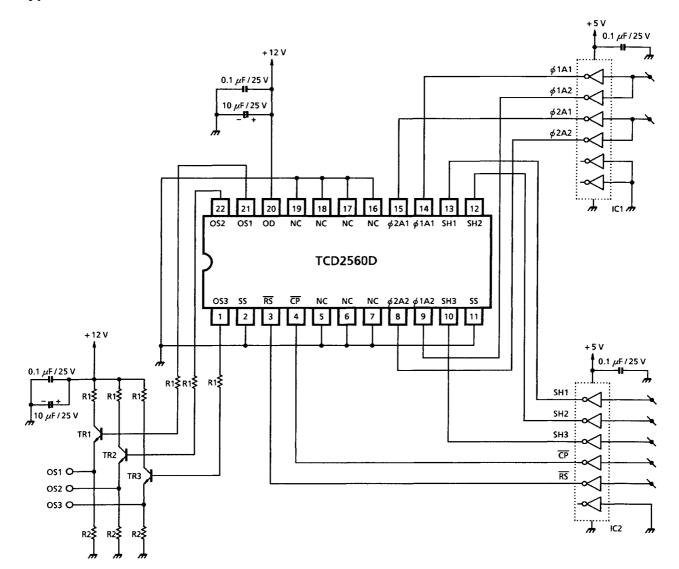
### **Clamp Mode**

| Clamp Means | CP Input Pulse  |  |  |
|-------------|---|--|--|
| Bit Clamp   | CP Pulse  |  |  |
| Line Clamp  | $\overline{CP} = \overline{SH}$ or $\overline{CP} = DC 5 V$ |  |  |

## **Typical Spectral Response**



### **Typical Drive Circuit**



IC1, 2: TC74HC04AP

TR1, 2, 3: 2SC1815-Y

R1: 150  $\Omega$ R2: 1500  $\Omega$ 

#### Caution

#### 1. Window Glass

The dust and stain on the glass window of the package degrade optical performance of CCD sensor. Keep the glass window clean by saturating a cotton swab in alcohol and lightly wiping the surface, and allow the glass to dry, by blowing with filtered dry N<sub>2</sub>.

Care should be taken to avoid mechanical or thermal shock because the glass window is easily to damage.

#### 2. Electrostatic Breakdown

Store in shorting clip or in conductive foam to avoid electrostatic breakdown.

CCD Image Sensor is protected against static electricity, but interior puncture mode device due to static electricity is sometimes detected. When handling the device, it is necessary to execute the following static electricity preventive measures, in order to prevent the trouble rate increase of the manufacturing system due to static electricity.

- (1) Prevent the generation of static electricity due to friction by making the work with bare hands or by putting on cotton gloves and non-charging working clothes.
- (2) Discharge the static electricity by providing earth plate or earth wire on the floor, door or stand of the work room.
- (3) Ground the tools such as soldering iron, radio cutting pliers of or pincer. It is not necessarily required to execute all precaution items for static electricity. It is all right to mitigate the precautions by confirming that the trouble rate within the prescribed range.

#### 3. Incident Light

CCD sensor is sensitive to infrared light.

Note that infrared light component degrades resolution and PRNU of CCD sensor.

#### 4. Lead Frame Forming

Since this package is not strong against mechanical stress, you should not reform the lead frame. We recommend to use a IC-inserter when you assemble to PCB.

#### 5. Soldering

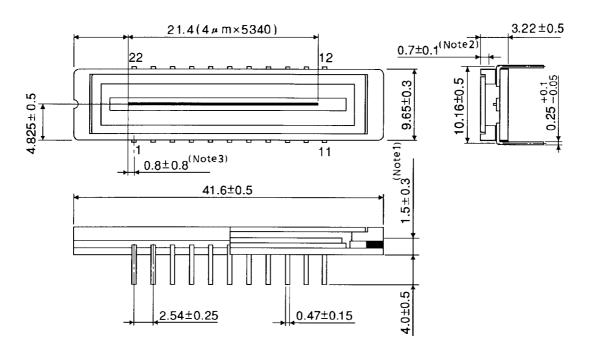
Soldering by the solder flow method cannot be guaranteed because this method may have deleterious effects on prevention of window glass soiling and heat resistance.

Using a soldering iron, complete soldering within ten seconds for lead temperatures of up to 260°C, or within three seconds for lead temperatures of up to 350°C.

Unit: mm

### **Package Dimensions**

WDIP22-G-400-2.54C(A)



Note 1: Top of chip to bottom of package

Note 2: Glass thickness (n = 1.5)

Note 3: No.1 sensor element (S1) to center of No.1 pin.

Weight: 4.5 g (typ.)

#### RESTRICTIONS ON PRODUCT USE

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